

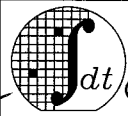
SMP

MAY 05 1995

PAD DIMENSIONS		
TYPE	X	Y
A	102	102
B	102	214
C	102	253

NOTES:
 All dimensions and coordinates are in microns. Coordinates are referenced to the geometric center of the die.

REV	DCN NO.	APPROVAL/DATE
00	23966	T.GALLOWAY 8/18/94
01	30271	<i>[Signature]</i> 4-19-95



Integrated Device Technology, Inc.
 2972 Stender Way, Santa Clara, CA, 95051
 (408) 727-6116 FAX: (408) 727-2328

7025 Y
(8K X 16K) DUAL-PORT RAM

DIE SIZE:
 6360 um x 9330 um

DRAWING NO.
PSC-4513

Thickness: 0.020"

SHEET 1 OF 2

PAD #	NAME	X	Y	TYPE
1	A 6L	-2868.4	3961.5	A
2	A 7L	-2868.4	3679.5	A
3	A 8L	-2868.4	3397.5	A
4	A 9L	-2868.4	3115.5	A
5	A 10L	-2868.4	2833.5	A
6	A 11L	-2868.4	2551.5	A
7	A 12L	-2868.4	2269.5	A
8	LB L	-2868.4	1987.5	A
9	UB L	-2868.4	1705.5	A
10	CE L	-2868.4	1423.5	A
11	SEM L	-2868.4	1141.5	A
12	R/W L	-2868.4	859.5	A
13	VCC	-2920.5	462.5	B
14	VCC	-2920.5	74.5	A
15	OE L	-2868.4	-308.5	A
16	I/O 0L	-2865.4	-1000.5	A
17	I/L 1L	-2865.4	-1207.5	A
18	GND	-2853.3	-1552	A
19	I/O 2L	-2865.4	-1896.5	A
20	I/O 3L	-2865.4	-2103.5	A
21	I/O 4L	-2865.4	-2462.5	A
22	I/O 5L	-2865.4	-2669.5	A
23	I/O 6L	-2865.4	-3028.5	A
24	I/O 7L	-2865.4	-3235.5	A
25	I/O 8L	-2865.4	-3607.5	A
26	I/O 9L	-2865.4	-3859.5	A
27	I/O 10L	-2460	-4201.4	A
28	I/O 11L	-2253	-4201.4	A
29	I/O 12L	-1894	-4201.4	A
30	I/O 13L	-1687	-4201.4	A
31	GND	-1342.4	-4189.3	A
32	I/O 14L	-998	-4201.4	A
33	I/O 15L	-791	-4201.4	A
34	VCC	-434.5	-4196.1	A
35	GND	183.5	-4189.3	A
36	I/O 0R	530.5	-4201.4	A
37	I/O 1R	737.5	-4201.4	A

PAD #	NAME	X	Y	TYPE
38	I/O 2R	1096.5	-4201.4	A
39	VCC	1370.6	-4196.1	A
40	I/O 3R	1625.5	-4201.4	A
41	I/O 4R	1984.5	-4201.4	A
42	I/O 5R	2191.5	-4201.4	A
43	I/O 6R	2550.5	-4201.4	A
44	I/O 7R	2864.9	-3927.5	A
45	I/O 8R	2864.9	-3518.5	A
46	I/O 9R	2864.9	-3311.5	A
47	I/O 10R	2864.9	-2952.5	A
48	I/O 11R	2864.9	-2745.5	A
49	I/O 12R	2864.9	-2386.5	A
50	I/O 13R	2864.9	-2179.5	A
51	I/O 14R	2864.9	-1820.5	A
52	GND	2852.8	-1552	A
53	I/O 15R	2864.9	-1283.5	A
54	OE R	2862.9	-590.5	A
55	R/W R	2862.9	-308.5	A
56	GND	2859.5	124.5	A
57	GND	2872.9	443	C
58	SEM R	2865	859.5	A
59	CE R	2865	1141.5	A
60	UB R	2865	1423.5	A
61	LB R	2865	1705.5	A
62	A 12R	2865	1987.5	A
63	A 11R	2865	2269.5	A

PAD #	NAME	X	Y	TYPE
64	A 10R	2865	2551.5	A
65	A 9R	2865	2833.5	A
66	A 8R	2865	3115.5	A
67	A 7R	2865	3397.5	A
68	A 6R	2865	3679.5	A
69	A 5R	2865	3961.5	A
70	A 4R	2376	4168	A
71	A 3R	2094	4168	A
72	A 2R	1812	4168	A
73	A 1R	1530	4168	A
74	A 0R	1248	4168	A
75	INT R	952	4191.8	A
76	BUSY R	593	4191.8	A
77	M/S L	349.5	4173.5	A
78	GND	-28	4179.7	A
79	BUSY L	-294.5	4191.8	A
80	INT L	-653.5	4191.8	A
81	A 0L	-1013.5	4168	A
82	A 1L	-1295.5	4168	A
83	A 2L	-1577.5	4168	A
84	A 3L	-1859.5	4168	A
85	A 4L	-2141.5	4168	A
86	A 5L	-2423.5	4168	A

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OO	23966	T.GALLOWAY 8/18/94			7025 Y (8K X 16) DUAL-PORT RAM	
O1	30271	<i>[Signature]</i> 9/19/95				
		MAY 05 1995	DIE SIZE: 6360 um x 9330um			
					DRAWING NO. PSC-4513	
			THICKNESS: 0.020"			
			SHEET 2 OF 2			